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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP	-	MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 - - 3.5			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	vise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	50 µA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.063	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		V _{DS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 6.0 A ^b	-	-	0.20	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 25 V, I _D = 0	6.0 A ^b	2.4	-	-	S
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	300	-	pF	
Output Capacitance	C _{oss}			-	160	-		
Reverse Transfer Capacitance	C _{rss}			-	29	-		
Total Gate Charge	Qg				-	-	11	1
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b		-	-	3.1	nC
Gate-Drain Charge	Q _{gd}				-	-	5.8	
Turn-On Delay Time	t _{d(on)}				-	10	-	
Rise Time	tr			_	50	-	- ns	
Turn-Off Delay Time	t _{d(off)}			_	13	_		
Fall Time	t _f			_	19	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	40		
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^\circ C, \ I_S = 10 \ A, \ V_{GS} = 0 \ V^b$		-	-	1.6	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \ ^{\circ}C, I_F = 10 \ A, dI/dt = 100 \ A/\mu s^b$		-	70	140	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.20	0.40	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated l				ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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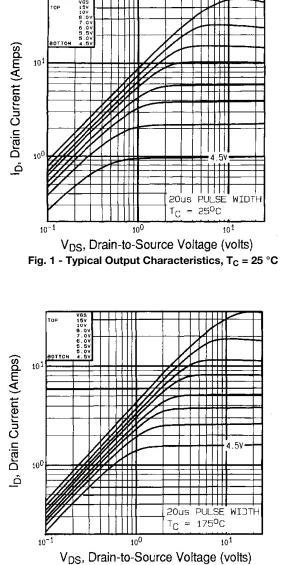


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$

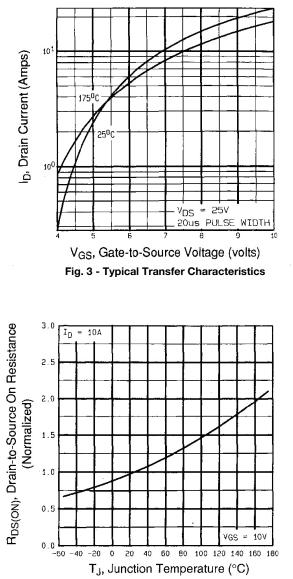


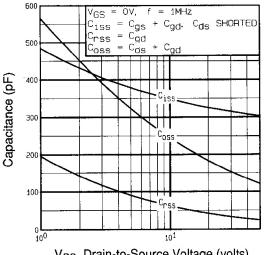
Fig. 4 - Normalized On-Resistance vs. Temperature

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V_{DS}, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

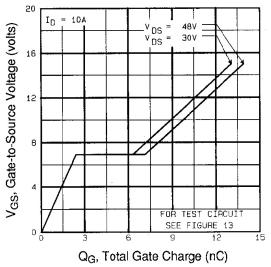
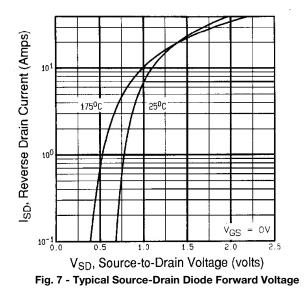
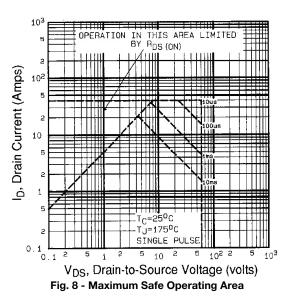


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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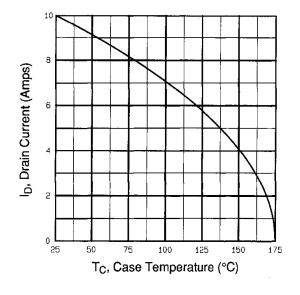


Fig. 9 - Maximum Drain Current vs. Case Temperature

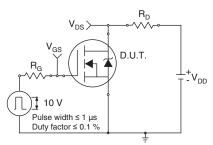


Fig. 10a - Switching Time Test Circuit

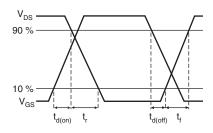
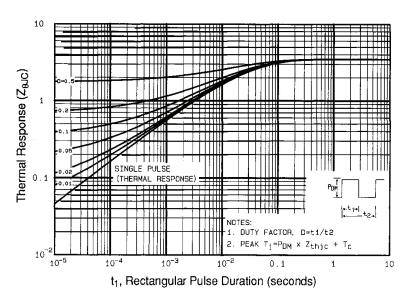
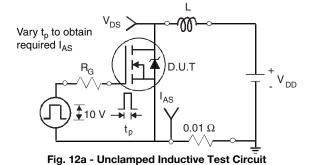


Fig. 10b - Switching Time Waveforms







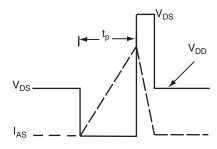


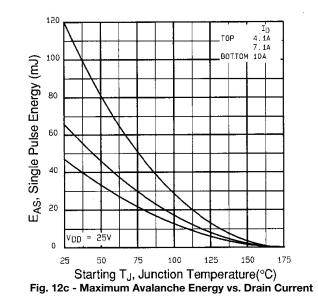
Fig. 12b - Unclamped Inductive Waveforms

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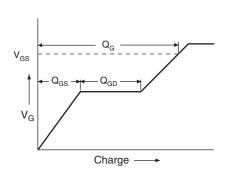
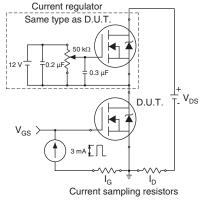


Fig. 13a - Basic Gate Charge Waveform





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Peak Diode Recovery dV/dt Test Circuit

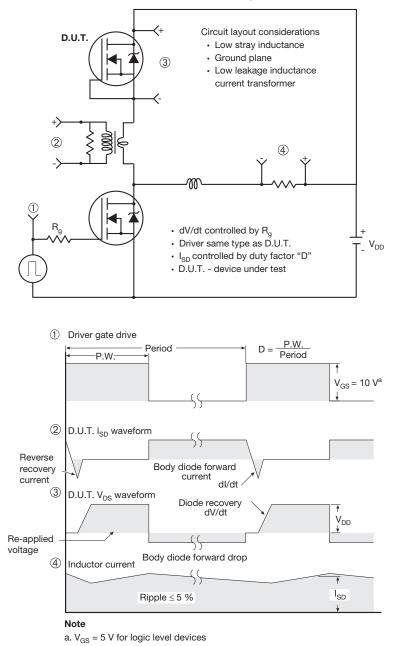
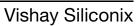


Fig. 14 - For N-Channel

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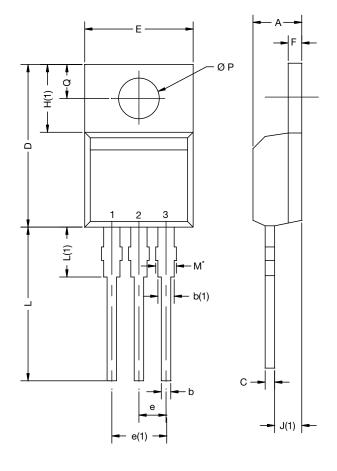
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
EGNEOA 7KAB 193 Co A		IRF 9510 744K AB 25 (C) (A)			

Revison: 14-Dec-15

Document Number: 66542

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